



US008373840B2

(12) **United States Patent**
Jeong

(10) **Patent No.:** **US 8,373,840 B2**
(45) **Date of Patent:** **Feb. 12, 2013**

(54) **LIQUID CRYSTAL DISPLAY DEVICE**

(75) Inventor: **Duk-Young Jeong**, Seoul (KR)

(73) Assignee: **LG Display Co., Ltd.**, Seoul (KR)

(*) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 6 days.

(21) Appl. No.: **13/011,422**

(22) Filed: **Jan. 21, 2011**

(65) **Prior Publication Data**

US 2011/0211151 A1 Sep. 1, 2011

Related U.S. Application Data

(62) Division of application No. 11/819,870, filed on Jun. 29, 2007, now Pat. No. 7,889,308.

(30) **Foreign Application Priority Data**

Jun. 30, 2006 (KR) 10-2006-0061597
Jun. 7, 2007 (KR) 10-2007-0055705

(51) **Int. Cl.**
G02F 1/1339 (2006.01)

(52) **U.S. Cl.** **349/153; 349/122; 349/127**

(58) **Field of Classification Search** 349/122,
349/127, 153-156, 149
See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

6,392,735 B1 *	5/2002	Tani	349/156
6,466,294 B1	10/2002	Yamagishi et al.	
6,473,147 B1	10/2002	Nakahara et al.	
2002/0005928 A1 *	1/2002	Hanakawa et al.	349/149
2002/0008815 A1 *	1/2002	Hanakawa et al.	349/113
2004/0125321 A1	7/2004	Park et al.	
2004/0246423 A1	12/2004	Sasabayashi et al.	

2006/0139553 A1 *	6/2006	Kang et al.	349/149
2007/0097306 A1	5/2007	Jung et al.	
2007/0120152 A1	5/2007	Chang et al.	
2007/0139600 A1	6/2007	Lee et al.	
2007/0153167 A1 *	7/2007	Jang et al.	349/110
2007/0268445 A1	11/2007	Chen et al.	
2008/0001864 A1	1/2008	Lee et al.	
2008/0123013 A1	5/2008	Kim	

FOREIGN PATENT DOCUMENTS

CN	1335531	2/2002
CN	1335531 A	2/2002
JP	4217228	8/1992
JP	8179345	7/1996
JP	11-149087	6/1999
JP	2000284296	10/2000
JP	2005-202360	7/2005
JP	2005-234090	9/2005
TW	200428085	12/2004

* cited by examiner

Primary Examiner — Ellen Kim

(74) *Attorney, Agent, or Firm* — Morgan, Lewis & Bockius LLP

(57) **ABSTRACT**

A liquid crystal display module includes an observation region to allow a visual inspection be performed after bonding of the substrates for inspecting the sealant that may be otherwise blocked by the common voltage line. An embodiment of a liquid crystal display device includes a first electrode on a first substrate, a second electrode and a third electrode on a second substrate, the second electrode electrically contacting the first electrode at a first portion and the third electrode at a second portion, and including a transparent conductive material, a sealant attaching the first and second substrates together in a sealant region, the sealant between the first and second electrodes and the sealant including a plurality of conductive balls for electrically connecting the first and second electrodes, and a liquid crystal layer between the attached first and second substrates and within the sealant.

13 Claims, 9 Drawing Sheets

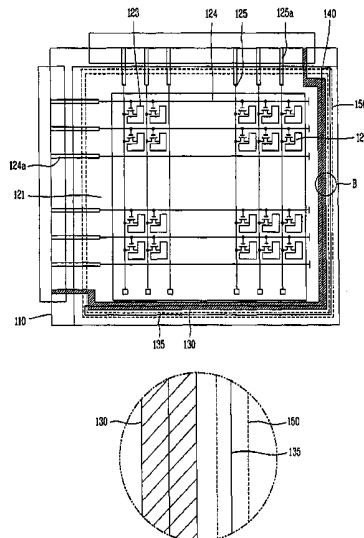


FIG. 1
RELATED ART

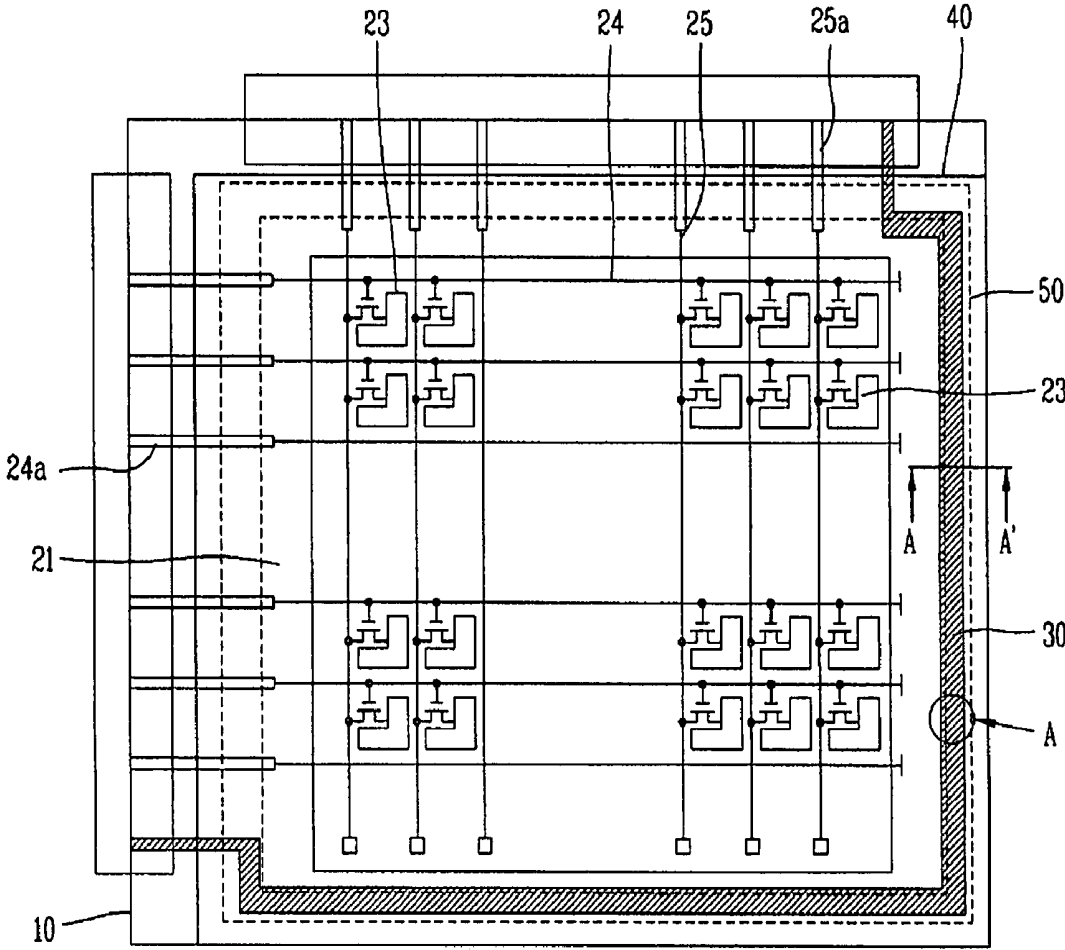


FIG. 2
RELATED ART

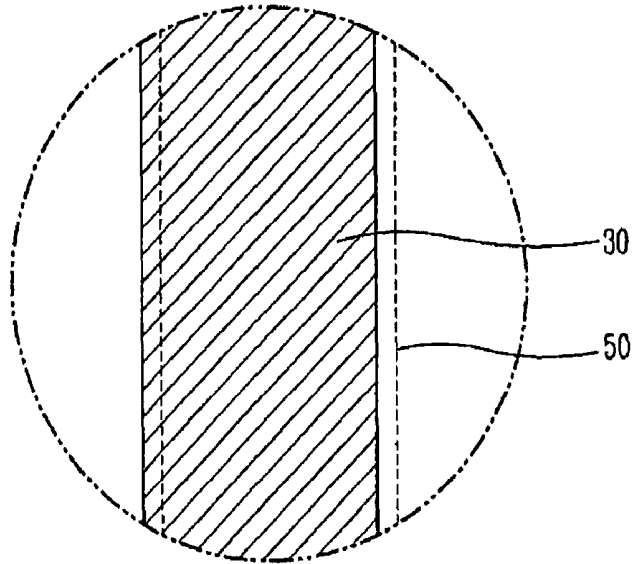


FIG. 3
RELATED ART

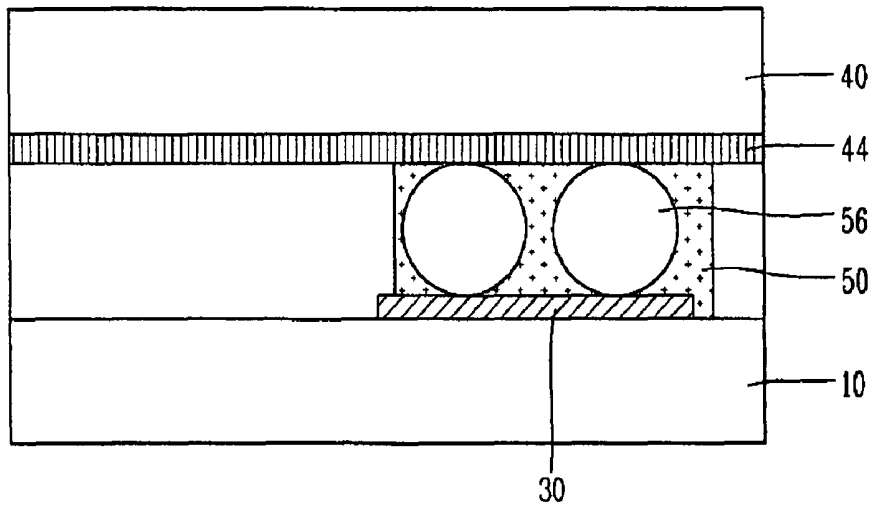


FIG. 4A

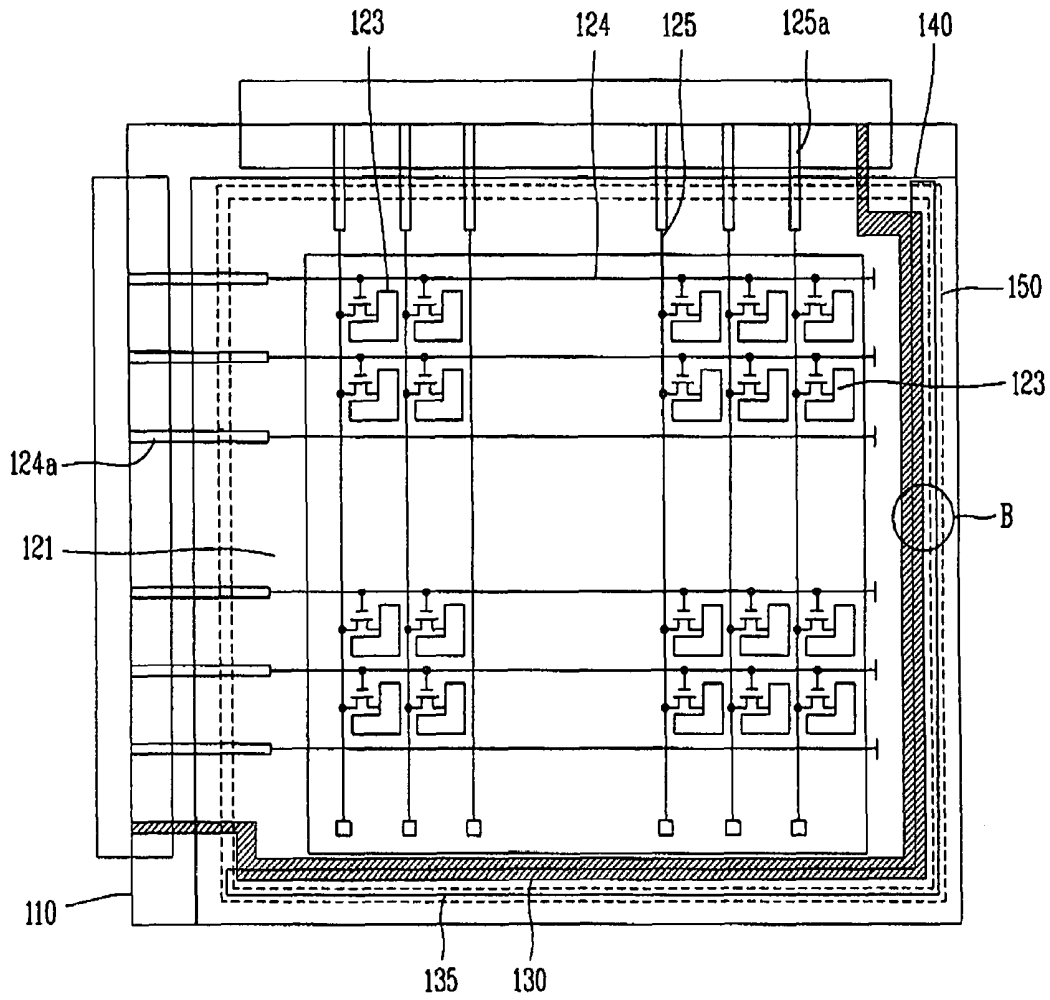


FIG. 4B

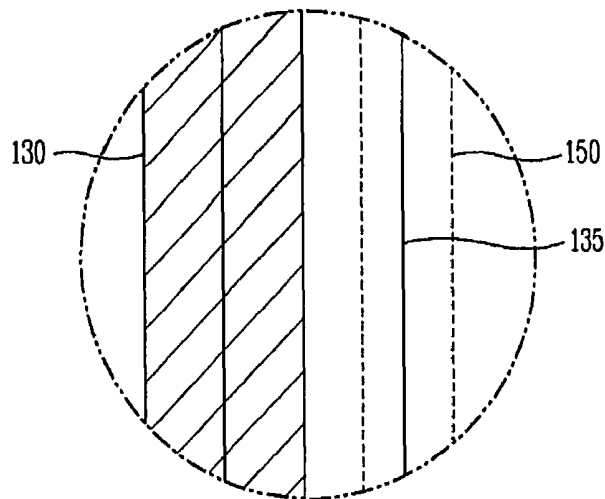


FIG. 5

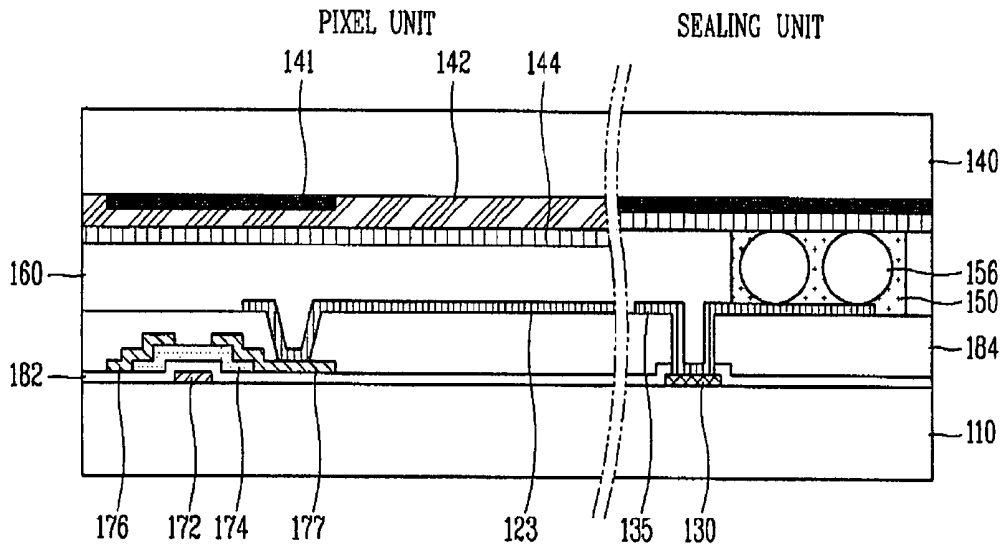


FIG. 6

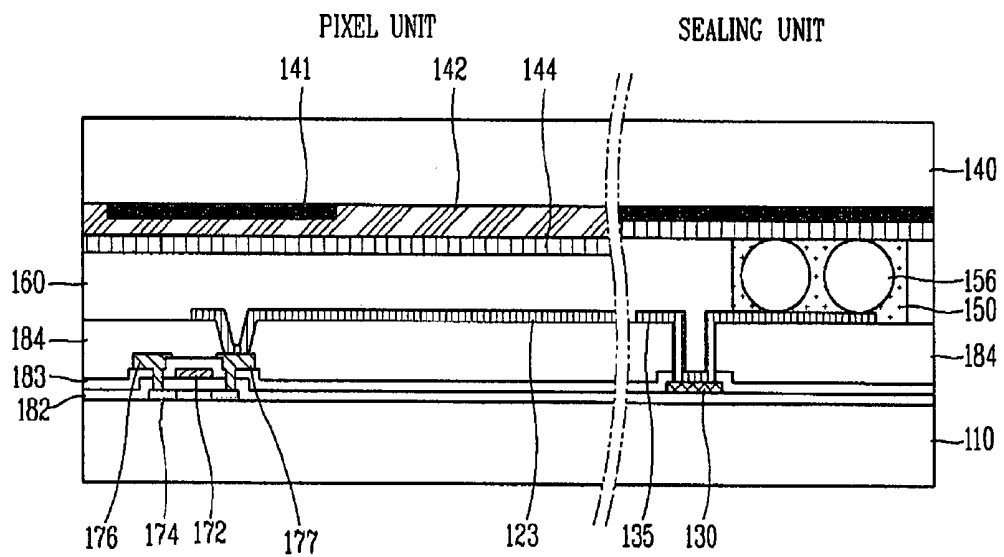


FIG. 7

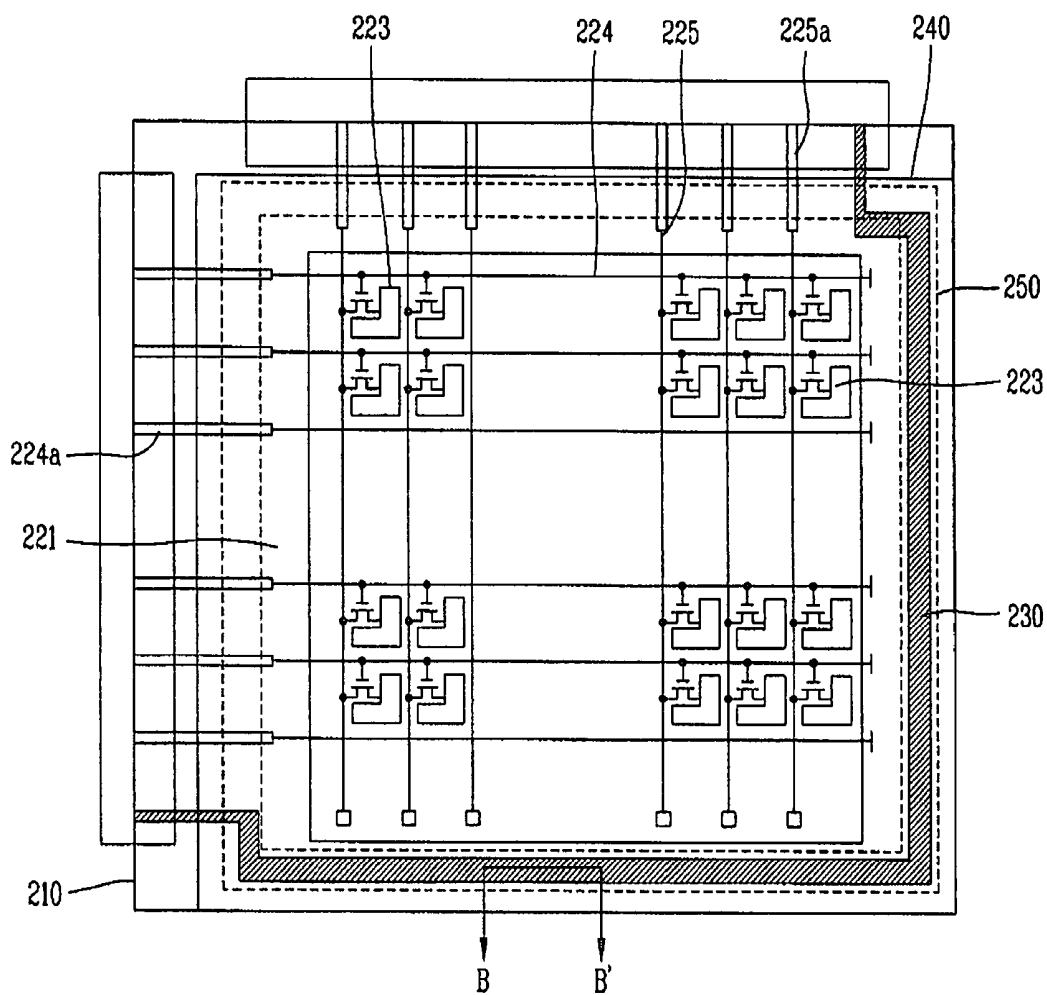


FIG. 8A

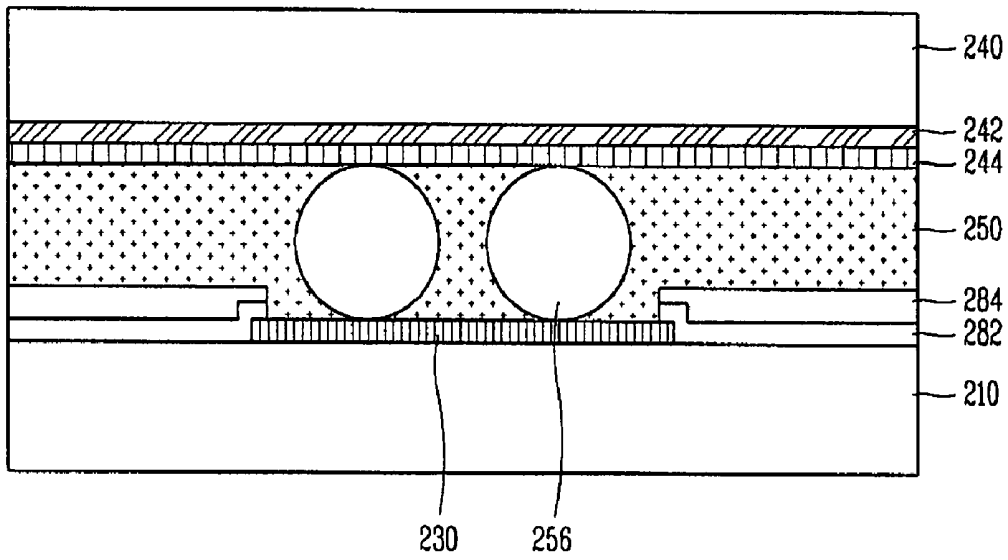


FIG. 8B

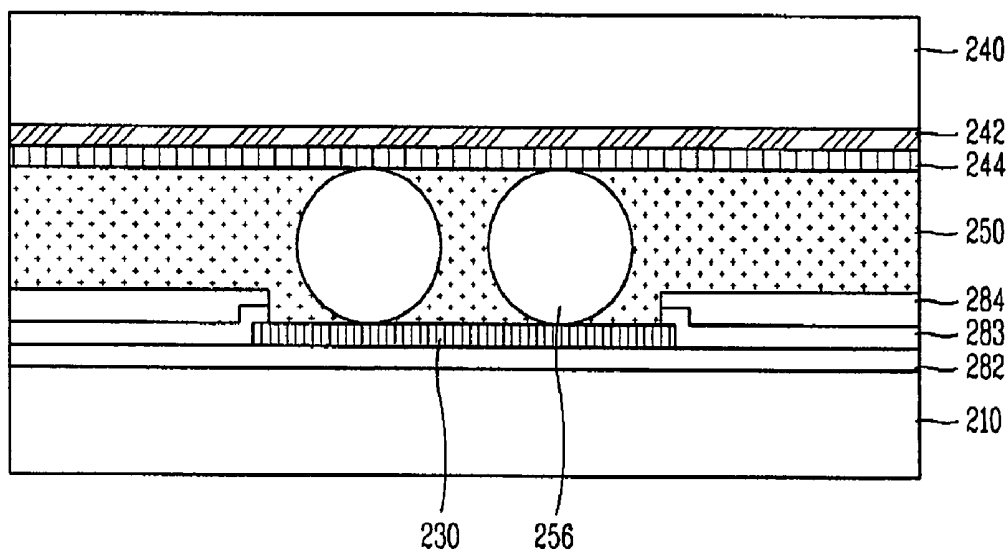


FIG. 9

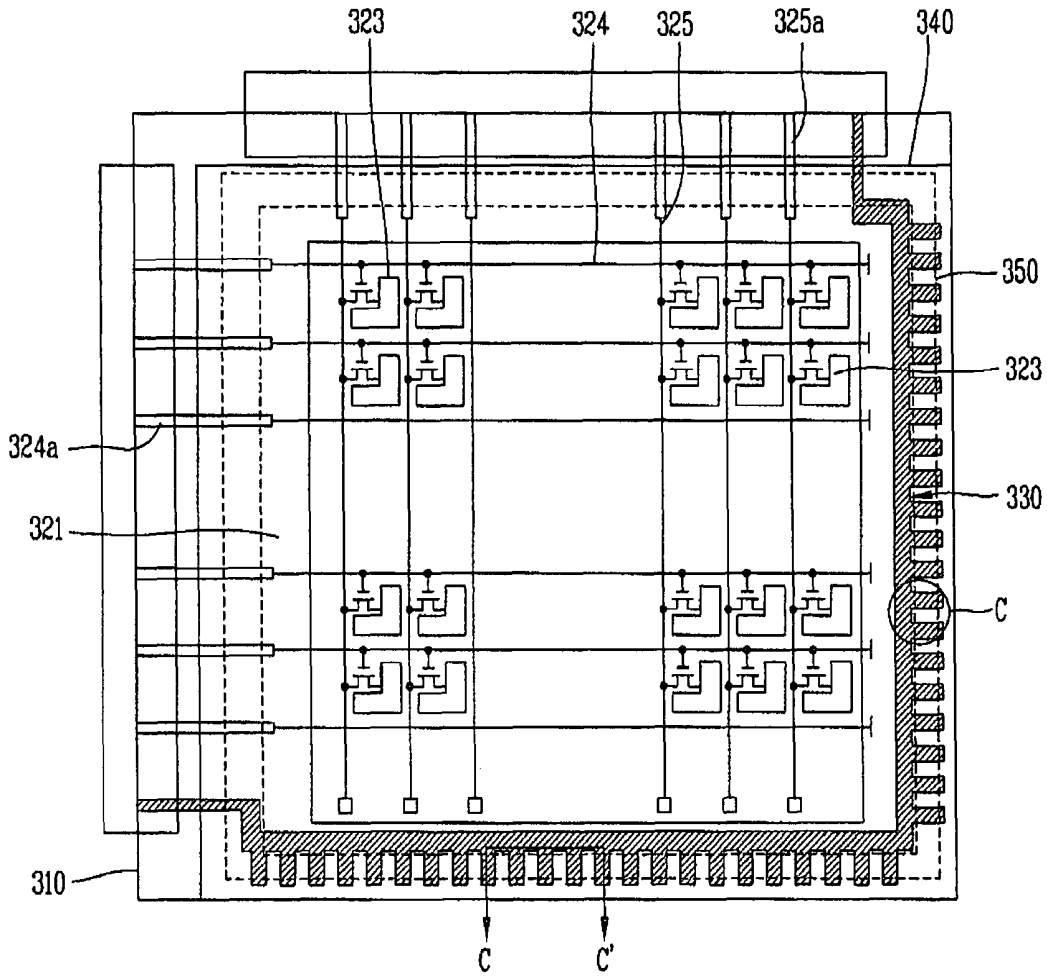


FIG. 10

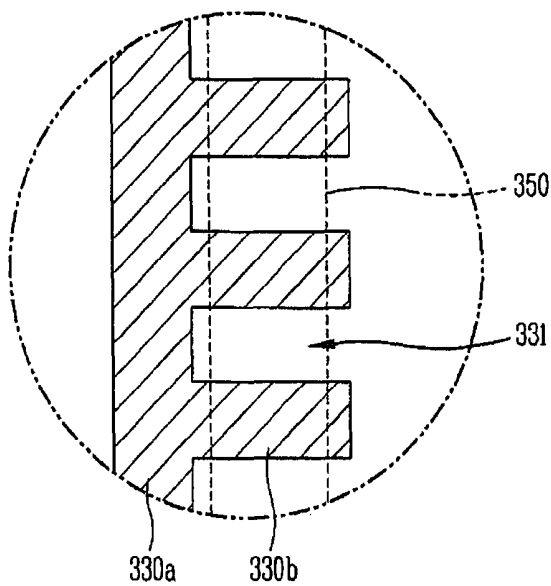


FIG. 11A

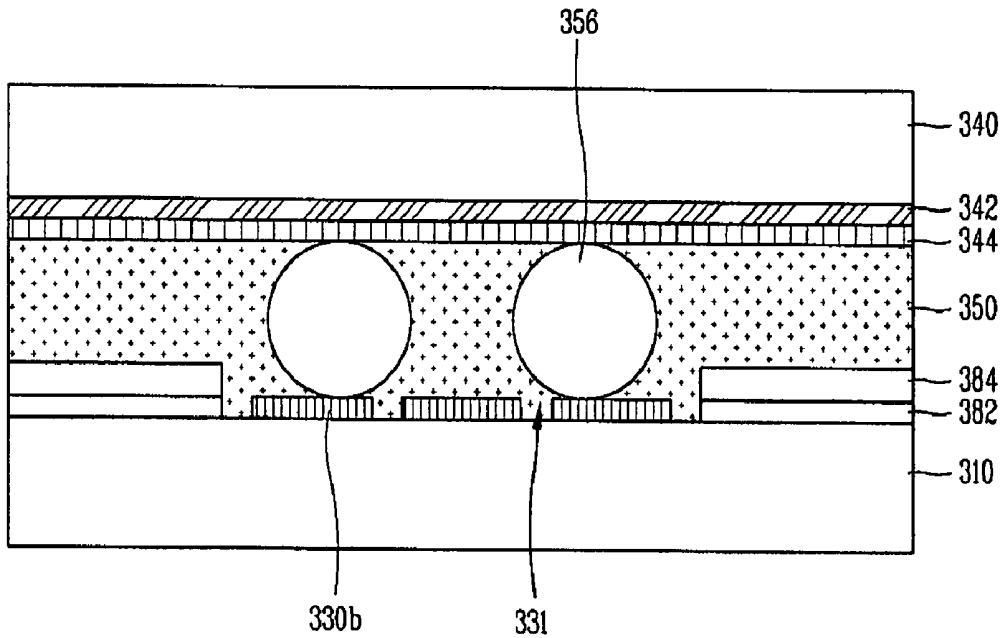


FIG. 11B

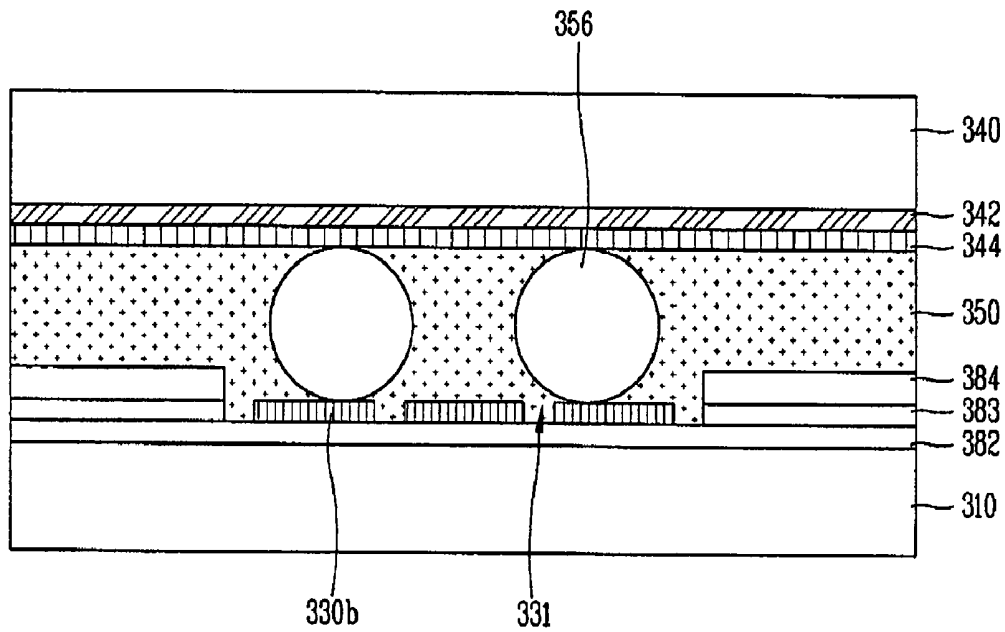


FIG. 12A

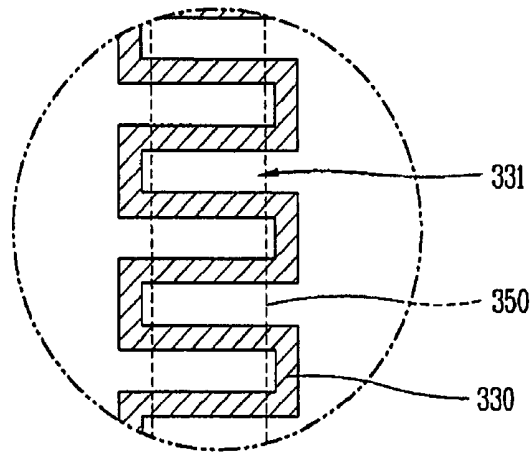


FIG. 12B

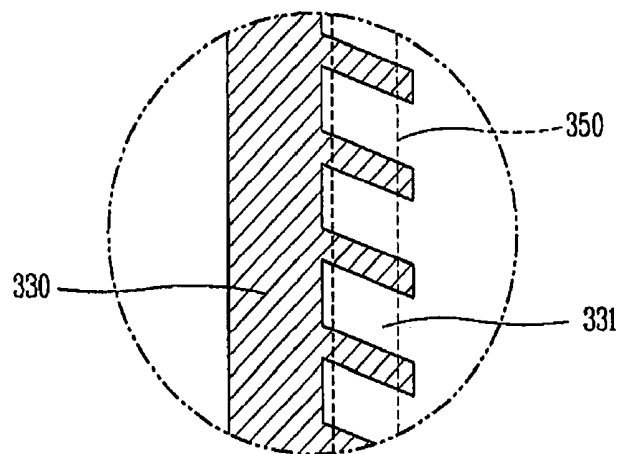
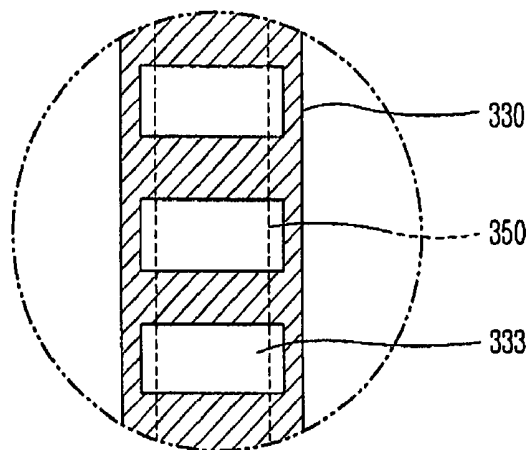


FIG. 12C



LIQUID CRYSTAL DISPLAY DEVICE

The present invention is a divisional patent application of patent application Ser. No. 11/819,870, filed on Jun. 29, 2007, which claims the benefit of Korean Patent Application Nos. 10-2006-0061597 and 10-2007-055705 filed in Korea on Jun. 30, 2006 and Jun. 7, 2007, which are hereby incorporated by reference in their entirety.

BACKGROUND OF THE INVENTION

1. Field Of The Invention

Embodiments of the invention relate to a liquid crystal display device, and more particularly, to a liquid crystal display device that allows effective visual inspections of a sealant and prevents defect generations in a sealant.

2. Discussion Of The Related Art

Cathode Ray Tubes (CRTs), which are traditionally utilized as information display devices, have advantages in functions and cost, but have disadvantages in size miniaturization and portability. On the other hand, recent advancement in semiconductor technology has allowed liquid crystal display (LCD) devices to have better functions. In particular, LCD devices advantageously become smaller and lighter and consume low power, and accordingly receive attentions as replacement for overcoming the disadvantages of the CRTs. Thus, the LCD devices have gradually replaced CRTs and increasingly become as the preferred display device for information processing equipment in the recent times.

Generally, an LCD device includes a lower substrate having a thin film transistor and a pixel electrode thereon, an upper substrate having a color filter layer of red (R), green (G) and blue (B) colors thereon, and a liquid crystal layer interposed between the lower and upper substrates. Upon fabricating a liquid crystal panel by bonding the lower and upper substrates, driving signal, e.g., gate signal, and data signal are applied to the liquid crystal panel region to generate an electric field on the pixel electrode, and the generated electric field twists liquid crystal molecules to adjust transmissivity of light emitted from a backlight, thereby implementing (displaying) images.

FIG. 1 is a plane view schematic diagram illustrating an LCD device according to the related art. As shown in FIG. 1, a plurality of gate lines 24 are arranged to cross a plurality of data lines 25 in a perpendicular manner on a lower substrate 10, thereby defining a plurality of pixel regions. A pixel electrode 23 is arranged in each of the plurality of pixel regions. A thin film transistor (TFT) which is a switching device is arranged at each intersection between the gate lines 24 and the data lines 25. Also, a gate pad 24a and a data pad 25a are electrically connected to one of the ends of the gate lines 24 and the data lines 25, respectively, to receive applied driving signal and data signal generated from a printed circuit board.

An upper substrate 40 has a common electrode (not shown) arranged at a region corresponding to an active region 21 of the LCD device and overlapping the pixel electrode. The common electrode receives a common voltage applied from an exterior via a common voltage line 30. The lower substrate 10 and the upper substrate 40 are bonded at their edges with a sealant 50.

FIG. 2 is an exploded view schematic diagram of region A shown in FIG. 1. As shown in FIG. 2, the sealant 50 is printed on the region on which the common voltage line 30 is located to form seal lines (shown by dashed lines). The sealant 50,

which is used to bond the lower substrate 10 and the upper substrate 40, overlaps the common voltage line 30 (shown as shaded).

FIG. 3 is a cross-sectional view schematic diagram along I-I' of FIG. 1. As shown in FIG. 3, the common voltage line 30 is formed on the lower substrate 10. The sealant 50 is coated on the common voltage line 30 to bond the lower substrate 10 and the upper substrate 40 together. The sealant 50 contains conductive balls 56. The conductive balls 56 come in contact with the common voltage line 30 on the lower substrate 10 and the common electrode 44 on the upper substrate 40 and supply a common voltage signal applied to the common voltage line 30 to the common electrode 44.

As such, the LCD device according to the related art employs the conductive balls 56 in the sealant 50 to supply the common voltage signal to the common electrode 44 on the upper substrate 40. Thus, the sealant 50 needs to overlap the common voltage line 30. However, the LCD device having such a structure may encounter the following problems.

An LCD device commonly undergoes an inspection for determining whether production defects are presented. The inspection commonly is performed not only in each production process but after the completion of the production process of the LCD device. Thus, the inspection of the sealant of the LCD device is performed not only at the sealant printing process but after the completion of the production process of the LCD device. During the inspection of the sealant at the sealant printing process, an assessment is made as to whether a preset amount of a sealant material has been printed.

In addition, the inspection of the sealant after the completion of the production process of the LCD device is performed on the sealant as it bonds the lower substrate 10 and the upper substrate 40 together. Thus, such an inspection of the sealant after the completion of the LCD production process is performed by a visual inspection. For example, the sealant is visually observed to inspect whether a line width of the sealant is non-uniform, whether the sealant has a crack or whether the sealant is partially separated.

However, the LCD device according to the related art employs the conductive balls in the sealant and has the sealant overlap the common voltage line. As a result, a visual inspection cannot be performed effectively on the sealant after the completion of the LCD production process due to the common voltage line formed of an opaque metal and the overlap between the common voltage line and the sealant.

SUMMARY OF THE INVENTION

Accordingly, embodiments of the invention is directed to a liquid crystal display device that substantially obviates one or more of the problems due to limitations and disadvantages of the related art.

An object of the embodiments of the invention is to provide a liquid crystal display device that allows effective visual inspections of a sealant and prevents defect generations in a sealant.

Another object of embodiments of the invention is to provide a liquid crystal display device capable of visually observing a line width of a sealant through an observation region in a common voltage line.

Another object of embodiments of the invention is to provide a liquid crystal display device capable of visually observing a sealant through a partially etching region in a common voltage line.

Additional features and advantages of embodiments of the invention will be set forth in the description which follows, and in part will be apparent from the description, or may be

learned by practice of embodiments of the invention. The objectives and other advantages of the embodiments of the invention will be realized and attained by the structure particularly pointed out in the written description and claims hereof as well as the appended drawings.

To achieve these and other advantages and in accordance with the purpose of embodiments of the invention, as embodied and broadly described, a liquid crystal display device includes a first electrode on a first substrate, a second electrode and a third electrode on a second substrate, the second electrode electrically contacting the first electrode at a first portion and the third electrode at a second portion, and including a transparent conductive material, a sealant attaching the first and second substrates together in a sealant region, the sealant between the first and second electrodes and the sealant including a plurality of conductive balls for electrically connecting the first and second electrodes; and a liquid crystal layer between the attached first and second substrates and within the sealant.

In another aspect, a liquid crystal display device includes a first electrode on a first substrate, a second electrode on a second substrate, the first electrode facing the second electrode, a sealant attaching the first and second substrates together, the sealant including a plurality of conductive balls and an observation region, the conductive balls electrically connecting the first and second electrodes and the observation region corresponding to a region where the sealant extends substantially parallel to the first electrode and does not overlap the first electrode; and a liquid crystal layer between the attached first and second substrates and within the sealant.

In another aspect, a liquid crystal display device includes a first substrate including a pixel electrode and a common voltage line thereon, the common voltage line having a plurality of etched portions, a second substrate including a common electrode thereon, the common electrode facing the pixel electrode in an active region of the device, and a sealant attaching the first and second substrates together, the sealant including a plurality of conductive balls and the conductive balls in electrical contact with the common voltage line and the common electrode, wherein the etched portions of the common voltage line provide a visual view of the sealant from the first substrate.

It is to be understood that both the foregoing general description and the following detailed description are exemplary and explanatory and are intended to provide further explanation of embodiments of the invention as claimed.

BRIEF DESCRIPTION OF THE DRAWINGS

The accompanying drawings, which are included to provide a further understanding of embodiments of the invention and are incorporated in and constitute a part of this specification, illustrate embodiments of the invention and together with the description serve to explain the principles of embodiments of the invention. In the drawings:

FIG. 1 is a plane view schematic diagram illustrating an LCD device according to the related art;

FIG. 2 is an exploded view schematic diagram of region A shown in FIG. 1;

FIG. 3 is a cross-sectional view schematic diagram along I-I' of FIG. 1;

FIG. 4A is a plane view schematic diagram illustrating an LCD device in accordance with a first embodiment of the invention;

FIG. 4B is an exploded view schematic diagram of region B shown in FIG. 4A;

FIGS. 5 and 6 are sectional views showing the structure of pixel of the first embodiment of present LCD device;

FIG. 7 is a plane view schematic diagram illustrating an LCD device in accordance with a second embodiment of the invention;

FIGS. 8A and 8B are sectional views showing the structure of sealing unit of the second embodiment of the present LCD device;

FIG. 9 is a plane view schematic diagram illustrating an LCD device in accordance with a third embodiment of the invention;

FIG. 10 is an exploded view schematic diagram of region C shown in FIG. 9;

FIGS. 11A and 11B are sectional views showing the structure of sealing unit of the third embodiment of the present LCD device;

FIG. 12A-12C are views showing the modifications of the third embodiment of this invention.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

Reference will now be made in detail to the preferred embodiments of the invention, examples of which are illustrated in the accompanying drawings.

FIGS. 4A and 4B are plane view schematic diagram illustrating an LCD device in accordance with a first embodiment of the invention. In FIG. 4A, an LCD device includes a lower substrate 110, an upper substrate 140 and a liquid crystal layer (not shown) interposed between the lower and upper substrates 110 and 140. The lower substrate 110 is bonded onto the upper substrate 140 by a sealant 150. The sealant 150 may be printed or coated by a screen printing method or a dispensing method on one or both of the lower substrate 110 or the upper substrate 140.

The lower substrate 110 includes a plurality of gate lines 124 and data lines 125 arranged thereon and defining a plurality of pixel regions. The lower substrate 110 also includes pixel electrodes 123 arranged therein the pixel regions and a thin film transistor (TFT) arranged in each of the pixel regions. Accordingly, by applying a signal to the TFT from the exterior via the gate lines 124, the TFT is controlled to selectively apply an image signal inputted via the data line 125 to the pixel electrode 123.

Also, a gate pad 124a and a data pad 125a are electrically connected to one of the ends of the gate lines 124 and the data lines 125 to supply signals from the exterior to the gate lines 124 and the data lines 125, respectively. The upper substrate 140 includes a common electrode (not shown) arranged at an active region 121 of the LCD device and facing the pixel electrodes 123 in each pixel region. A common voltage is applied to the common electrode via a common voltage line 130 to form an electric field across the common electrode and the pixel electrode 123.

Although not shown detail in figure, a gate tap carrier package (TCP) and a data TCP are attached to the lower substrate 110. The gate TCP and the data TCP respectively have a gate driving IC and a data driving IC mounted therein. The gate TCP and the data TCP respectively supply a scanning signal and an image signal to a gate pad 124a and a data pad 125a arranged on the lower substrate 110. Also, the data TCP 180b may further include various circuits, such as a common voltage generating circuit. The common voltage generating circuit is electrically connected to the common voltage line 130 on the lower substrate 110 to apply a common voltage to the common voltage line 130.

In addition, the common voltage line 130 is arranged along two edges of the lower substrate 110. Alternatively, the common voltage line 130 may be arranged differently, for example, along three edges or all edges of the lower substrate 100. Further, the sealant 150 is arranged on edges of one or both of the lower substrate 110 and the upper substrate 140 to bond the lower and upper substrates 110 and 140 together.

As shown in FIG. 4B, the common voltage line 130 is apart from the sealant 150 in the predetermined distance and a conductive line 135 is disposed between the common voltage line 130 and the sealant 150 so that the conductive line 135 is overlapped with at least a part of the common voltage line 130 and the sealant 150. The conductive line 135 is made of a transparent material such as an indium tin oxide and a tin zinc oxide.

The sealant 150 is connected to the common electrode on the upper substrate 140 and contains a plurality of conductive balls. The conductive line 135 is overlapped and connected with the common voltage line 130 and the sealant 150 and thus the common voltage supplied to the common voltage line 130 is applied to the common electrode of the upper substrate 140 through the conductive line 135 and the sealant 150. At that time, since the conductive line 135 has a width broader than that of the sealant 150, the conductive line 135 may be overlapped with the whole area of the sealant 150 or a part of the sealant 150.

Since the conductive line 135 is transparent, it is possible to observe the sealant 150 corresponding to the conductive line 135 by the operator's eye. That is, the operator can observe the shape of the sealant 150 by his eye to detect the width and inferiority of the sealant 150.

The sealant 150 is disposed on the conductive line 135 to connect the sealant 150 with the conductive line 135. Further, the common voltage line 130 is formed on the different layer from the conductive line 135 and connected to the conductive line 130 through a contact hole formed in the insulating layer between the common voltage line 130 and the conductive line 135.

FIGS. 5 and 6 are sectional views showing the LCD device according to the first embodiment of the present invention. At this time, FIG. 5 indicates the LCD device having a TFT (thin film transistor) of bottom gate type and FIG. 6 indicates the LCD device having a TFT of top gate type. In figures, the LCD device is divided into pixel unit and sealing unit for convenience.

Referring to FIG. 5, the LCD device includes a lower substrate 110 and an upper substrate 140. On the lower substrate, a gate electrode 172 is formed in the pixel unit and the common voltage line 130 is formed in the sealing unit. The gate electrode 172 and the common voltage line 130 may be made by the different processes. However, it is proper to form the gate electrode 172 and the common voltage line 130 with same metal by the same process.

A gate insulating layer 182 is formed on the lower substrate 110 and a semiconductor layer 174 such as a-Si is formed on the gate insulating layer 182 in the pixel unit. Further, a source electrode 176 and a drain electrode 177 are formed on the semiconductor layer 174, and a passivation layer 184 is formed on the whole area of the lower substrate 184.

On the passivation layer 184, a pixel electrode 123 is formed in the pixel unit and the conductive line 135 is formed on the sealing unit. The pixel electrode 123 and the conductive line 135 may be formed by the different processes. However, it is proper to form pixel electrode 123 and the conductive line 135 with same material such as indium tin oxide and indium zinc oxide by the same process. Contact holes are formed in the passivation layer 184 at the pixel unit and

sealing unit, so that the pixel electrode 123 is connected to the drain electrode 177 through the contact hole of the passivation layer 184 in the pixel unit and the conductive line 135 is connected to the common voltage line 130 through the contact hole of the passivation layer 184 in the sealing unit.

In the sealing unit, the sealant 150 is formed. Since the sealant 150 is formed on the common voltage line 130, the conductive ball 156 contained in the sealant 150 is contacted with the common voltage line 130 to connect electrically the conductive ball 156 to the common voltage line 130. Although a part of sealant 150 is overlapped and connected with the common voltage line 130, the common voltage line 130 may be formed in the width larger than from that of the sealant 150 to overlap the common voltage line 130 with the whole width of the sealant 150.

A black matrix 141 is formed in the pixel unit and the sealing unit on the upper substrate 140. The black matrix is disposed in the non-display region such as TFT forming region, the gate line region, and the data line region to block the light through the non-display region. A color filter layer 142 is formed on the upper substrate 140 and a common electrode 144 made of the transparent material such as indium tin oxide and indium zinc oxide on the color filter layer 142 of the pixel unit and the black matrix 141 of the sealing unit.

The lower and upper substrates 110 and 140 are attached each other by the sealant 150 of the sealing unit and a liquid crystal layer 160 is formed between the lower and upper substrates 110 and 140.

The conductive ball 156 in the sealant 150 is contacted with the common electrode 144 in the sealing unit. Thus, the common voltage line 130 in the lower substrate 110 is connected to the common electrode 144 in the upper substrate 140 through the conductive line 135 and the conductive ball 156. When the common voltage is supplied from the outer driver (not shown), the common voltage is applied to the common voltage 144 of the upper substrate 140 through the common voltage line 130, the conductive line 135, and the conductive ball 156 to generate the electric field between the common electrode 144 and the pixel electrode 123.

In this embodiment, the transparent conductive line 135 is disposed between the common voltage line 130 and the sealant 150 to connect the conductive line 135 to the common voltage line 130 and the sealant 150. Thus, since the sealant 150 is overlapped with the transparent conductive line 135, not the opaque common voltage line 130, the shape of the sealant 150 may be observed by the operator through the transparent conductive line 135 and as a result the width and inferiority of the sealant 150 can be detected.

We will describe the TFT of top gate type in the FIG. 6 as follows. At this time, the description for the structure shown in FIG. 5 will be omitted.

As shown in FIG. 6, the semiconductor layer 174 is formed in the pixel unit on the lower substrate 110. The semiconductor layer 174 is formed with a poly-crystalline silicon (p-Si) or the a-Si. An impurity is injected in the both sides of the semiconductor to form an ohmic contact layer.

The gate insulating layer 182 is formed on the whole area of the lower substrate 110. A gate electrode 172 is formed in the pixel unit on the gate insulating layer 182 and the common voltage line 130 is formed in the sealing unit on the gate insulating layer 182. The gate electrode 172 and the common voltage line 130 may be made by the different processes. However, it is proper to form the gate electrode 172 and the common voltage line 130 with same metal by the same process.

Over the lower substrate 110 on which the gate electrode 172 and the common voltage line 130 are formed, an inter-

layer **183** is deposited. The source electrode **176** and the drain electrode **177** are formed in the pixel unit on the interlayer **183** and the passivation layer **184** is formed over the whole area of the lower substrate **110**. The source electrode **176** and the drain electrode **177** are connected to the semiconductor layer **174** through the contact hole formed in the gate insulating layer **182** and the interlayer **183**.

On the passivation layer **184**, the pixel electrode **123** is formed in the pixel unit and the conductive line **135** is formed in the sealing unit. The pixel electrode **123** and the conductive line **135** which are formed with the transparent material such as the indium tin oxide or the indium zinc oxide are respectively connected to the drain electrode **177** and the common voltage line **130** through the contact holes formed in the passivation layer **184**.

The black matrix **141** is formed in the pixel unit and the sealing unit on the upper substrate **140** and the color filter layer **142** is formed in the pixel unit on the upper substrate **140**. Further, the common electrode **144** which is made of the transparent material such as the indium tin oxide and the indium zinc oxide is disposed on the color filter layer **142** in the pixel unit and on the common electrode **144** in the sealing unit.

In the sealing unit on the lower substrate **110**, the sealant **150** is formed to attach the lower and upper substrates **110** and **140**. The sealant **150** is disposed on the common voltage line **130**, so that the conductive ball **156** of the sealant **150** is contacted with the conductive line **135** of the lower substrate **110** and the common electrode **144** of the upper substrate **140** to connect electrically the common voltage line **130** and the common electrode **144**.

In this embodiment, since the sealant **150** is overlapped with the transparent conductive line **135**, not the opaque common voltage line **130**, the shape of the sealant **150** may be observed by the operator through the transparent conductive line **135** and as a result the width and inferiority of the sealant **150** can be detected.

FIG. 7 is a view showing the LCD device according to the second embodiment of the present invention. At this time, we will describe only the different structure from the first embodiment, not the same element as the first embodiment.

As shown in FIG. 7, in this embodiment, the common voltage line **230** is made of the transparent material and directly contact with the sealant **250**. That is, the common voltage line **230** is superposed with the sealant **250**. Since the common voltage line **230** is made of the transparent material such as the indium tin oxide or the indium zinc oxide, the shape of the sealant **250** may be observed by the operator through the transparent common voltage line **230**. FIGS. 8A and 8B are the sectional views along B-B' line of FIG. 7 showing the structure of the sealing unit of the LCD device. At this time, FIG. 8A indicates the LCD device having a TFT (thin film transistor) of bottom gate type and FIG. 8B indicates the LCD device having a TFT of top gate type.

As shown in FIG. 8A, in the LCD device having TFT of bottom gate type, the common voltage line **230** made of the transparent conductive material is formed on the lower substrate **210**. At this time, the gate insulating layer **282** and the passivation layer **284** upper the common voltage line **230** is removed to expose the common voltage line **230**. The sealant **250** is formed on the expose region of the common voltage line **230**. The conductive ball **256** of the sealant **250** is contacted with the common voltage line **230** and the common electrode **244** in the upper substrate **240** to connect electrically the common voltage line **230** and the common electrode **244**. Thus, the common voltage supplied to the common

voltage line **230** is applied to the common electrode **244** through the conductive ball **256**.

As shown in FIG. 8B, in the LCD device having TFT of top gate type, the common voltage line **230** made of the transparent conductive material such as the indium tin oxide and the thin zinc oxide is formed on the gate insulating layer **282**. At this time, the interlayer **283** and the passivation layer **284** upper the common voltage line **230** is removed to expose the common voltage line **230**. The sealant **250** is formed on the expose region of the common voltage line **230**, so that the common voltage line **230** is electrically connected to the common electrode **244** by the conductive ball **156**.

Since the transparent common voltage line **230** is contacted with the sealant **250**, the shape of the sealant **250** may be observed by the operator through the transparent common voltage line **230**.

In this invention, as described above, the transparent common voltage line is directly connected to the sealant or the opaque common voltage line is connected to the sealant through the transparent conductive line to apply the common voltage to the common electrode. Thus, the sealant **250** may be detected through the transparent layer, i.e., the common voltage line or the conductive line.

Also, the observation of the sealant may be performed after bonding the lower substrate and the upper substrate together. For example, after the completion of the fabrication process of a liquid crystal display module, the line width of the sealant is inspected in an overall module inspection process.

Accordingly, although the line width of the sealant may pass an inspection at the sealant printing process, if the inspection made after the completion of the fabrication process of the LCD module finds the line width being less than a preset line width or any line-width defect is generated at the line width (e.g., introduction of foreign material or cracks or holes on a coated sealant), the complete LCD module would be determined as a defective one. As a result, the product undergoes a more stringent inspection and defects in finished products are prevented.

FIG. 9 is a plan view showing the LCD device according to the third embodiment of this invention and FIG. 10 is a partially enlarged plan view of C-region of FIG. 9. In this embodiment, the common voltage line is made of the opaque metal and directly contacted with the sealant. In order to observe the shape of the sealant, in this invention, the window for observing the sealant is formed in the opaque common voltage line. This structure is described in detail as follow.

As shown in FIG. 9, the common voltage line **330** is formed along two sides, three sides, or all sides of the lower substrate **310**, and the sealant **350** is formed in the outside of the lower and upper substrates **310** and **340** to attach thereof. The common voltage line **330** is made of opaque metal and the sealant **350** is overlapped with a part of the common voltage line **330**.

As shown in FIG. 10, the common voltage line **330** includes a plurality of protrusions **330b** protruded from a main common voltage line portion **330a**. The sealant **350** is arranged on the common voltage line **330** and overlaps the common voltage line **330**. The sealant **350** has a width smaller than that of the protrusions **330b** so that the sealant **350** is entirely overlapped with the protrusions **330b**. At this time, the sealant **350** can be formed in the width larger than that of the protrusions **330b** so that the sealant **350** can be overlapped with the a part of the main common voltage line **330a** and the protrusions **330b**.

The conductive ball in the sealant **350** is contacted with the protrusions **330b** to connect electrically the common voltage line **330** to the sealant **350** and a result the common voltage is applied to the common electrode in the upper substrate **340**.

The protrusions **330b** may be arranged with a preset width and a preset interval. Therefore, the LCD device according to this embodiment of the invention, unlike an LCD device of the related art, includes an opening, in the common voltage line **330**, where no metal or an opaque material is disposed. The opening may correspond to a region between two protrusions **330b** of the common voltage line **330**. In addition, the opening forms a transmittable region to allow visual inspections, for example, a region for inspecting a line width of the sealant **350** that is arranged on the common voltage line **330**. Accordingly, an operator can visually observe the shape of the sealant **350** through the opening, thereby inspecting the line width of the sealant **350** and any defect generation.

FIGS. **11A** and **11B** are sectional views along line C-C' of FIG. **10**. At that time, FIG. **11A** indicates the LCD device having a TFT (thin film transistor) of bottom gate type and FIG. **11B** indicates the LCD device having a TFT of top gate type.

As shown in FIG. **11A**, in the LCD device of the bottom gate type, the protrusions **330b** of the common voltage line **330** is formed on the lower substrate **310**. Although not shown, the main common voltage line **330a** connected to the protrusions **330b** is formed on the lower substrate **310**. Since, the common voltage line **330** may be formed of the same metal as the source and drain electrodes and by the same fabrication process. For example, the protrusions **330b** and the main common voltage line **330a** can be formed by laminating a metal of a uniform width and then partially etching the laminated metal by a photolithography.

The gate insulating layer **382** and the passivation layer **384** over the protrusions **330b** are removed to expose the protrusions **330b** and the sealant **350** is formed on exposed protrusions **330b** so that the conductive ball **356** of the sealant **350** is contacted with the protrusions **330b**. Further, the conductive ball **356** is contacted with the common electrode **344** in the upper substrate **340**. Thus, the common voltage line **330** is connected to the common electrode **344** through the conductive ball **356** of the sealant **350**.

As shown in FIG. **11B**, in the LCD device of the bottom gate type, the protrusions **330b** are formed on the gate insulating layer **382** and the interlayer **383** and the passivation layer **384** on the protrusions **330b** are removed to expose the protrusions **330b**. The sealant **350** is disposed on the exposed protrusions **330b** to contact the conductive ball **356** of the sealant **350** with the protrusions **330b** and as a result the common voltage line **330** is electrically connected to the common voltage.

As described above, the third embodiment of the invention includes a light-transmittable observation region **331** formed by partially etching the common voltage line **330** and a visual inspection of the sealant **350** can be made through the observation region **331** in the common voltage line **330**.

In embodiment, the sealant **350** is directly overlapped with the opaque common voltage line **330** to connect electrically the common voltage line **330** in the lower substrate **310** to the common electrode **344** in the upper substrate **340**. At this time, the protrusions **330b** of the common voltage line **330** is connecting line for connecting the common voltage line **330** and the common electrode **344** and the main common voltage line **330a** is a voltage applying line to which the voltage is applied.

In this embodiment, the observing region **331** is formed in the opaque common voltage line **330** to observe the shape of the sealant **350** through the observation region **331**. Thus, this embodiment is applicable to the modifications having the various structure if the observation region is provided to the common voltage line.

FIG. **12A-12C** are views showing the modifications of the third embodiment of this invention.

As shown in FIG. **12A**, the common voltage line **330** may be formed in a zigzag shape with a certain width. The common voltage line **330** includes an observation region **331** between the changes of the line direction to allow a visual observation of a sealant **350** printed on the common voltage line **230**.

As shown in FIG. **12B**, protrusions of the common voltage line **330** may be arranged at non-perpendicular with respect to the main line direction. The common voltage line **330** includes an observation region **331** between two protrusions to allow the visual observation of the sealant **350** printed on the common voltage line **330**.

As shown in FIG. **12C**, the common voltage line **330** includes a plurality of windows **332** within its main line portion. The common voltage line **330** includes the window to allow the visual observation of the sealant **350** printed on the common voltage line **330**. The window **332** may be formed in a rectangular shape as shown in FIG. **7C**, but may have other shapes, such as a circular shape or a triangular shape.

As described above, according to an embodiment of the invention, the common line is made of transparent material or includes a plurality of protrusions and observation regions. Alternatively, according to an embodiment of the invention, a transparent electrode electrically connects conductive balls of the sealant and the common voltage line in regions where the sealant and the common voltage line extend parallel to one another. As such, according to an embodiment of the invention, an LCD module includes an observation region to allow a visual inspection of a sealant that may be otherwise blocked by the common voltage line. Thus, according to an embodiment of the invention, an effective visual inspection of a sealant can be performed after the completion of the fabrication process of an LCD module and an LCD module having a fabrication defect, such as a bonding defect or sealant line-width defect, can be detected, thereby preventing weak bonding of the substrates or liquid crystal leakage.

The line shapes shown in figures are merely exemplary. For example, the common voltage line according to an embodiment of the invention may have a different structure from those shown in the figures. Therefore, an embodiment of the invention may not be limited to the illustrated shapes, but can also be implemented in various shapes. In addition, the detailed explanation described above has been provided for a certain LCD device, but the present invention may not be limited to the LCD device having the construction as shown. The present invention may be applicable to LCD devices in which a common electrode is formed on an upper substrate and a common voltage is applied to the common electrode via conductive balls contained in sealant.

It will be apparent to those skilled in the art that various modifications and variations can be made in the liquid crystal display device of embodiments of the invention without departing from the spirit or scope of the invention. Thus, it is intended that embodiments of the invention cover the modifications and variations of this invention provided they come within the scope of the appended claims and their equivalents.

What is claimed is:

1. A liquid crystal display device comprising:
 - a first electrode on a first substrate having a plurality of pixel regions and a non-displaying unit disposed at an outer region of the displaying unit;
 - a second electrode on a second substrate, the first electrode facing the second electrode;
 - a sealant disposed in the non-displaying unit to attach the first and second substrates together, the sealant includ-

11

- ing a plurality of conductive balls and an observation region, the conductive balls electrically connecting the first and second electrodes and the observation region being formed at a region where the sealant extends substantially parallel to the first electrode and does not overlap the first electrode in the non-displaying unit so that the sealant is exposed through the observation region; and
- a liquid crystal layer between the attached first and second substrates in the displaying unit, wherein the conductive balls are directly contacted to the first electrode on the first substrate.
2. The device according to claim 1, wherein the first electrode includes a plurality of protrusions extending from a main line portion, and the observation region corresponds to the region between two of the immediately adjacent protrusions of the first electrode.
3. The device according to claim 2, wherein the protrusions extend perpendicularly from the main line portion.
4. The device according to claim 2, wherein the protrusions extend at a non-90° angle from the main line portion.
5. The device according to claim 1, wherein the first electrode includes a plurality of windows and the observation region corresponds to the windows.
6. The device according to claim 1, wherein the first electrode has a zigzag shape.
7. The device according to claim 1, further comprising: a common voltage source selectively applying a common voltage to the second electrode through the first electrode and the sealant.
8. The device according to claim 1, wherein the first substrate includes a pixel electrode in the pixel region, wherein the second electrode faces the pixel electrode in the pixel region.
9. The device according to claim 1, wherein the first electrode is arranged in a winding manner arranged along at least one edge of the liquid crystal display device.

12

10. The device according to claim 1, wherein the first and second electrodes include a non-transparent conductive material.
11. A liquid crystal display device comprising:
 a first substrate including a displaying unit to display an image and a non-displaying unit formed at the outer region of the displaying unit;
 a pixel electrode disposed in the displaying unit on the first substrate and a common voltage line disposed in the non-displaying unit on the first substrate, the common voltage line having a plurality of etched portions;
 a second substrate including a common electrode thereon, the common electrode facing the pixel electrode in an active region of the device; and
 a sealant disposed in the non-displaying unit to attach the first and second substrates together, the sealant including a plurality of conductive balls and the conductive balls in electrical contact with the common voltage line and the common electrode,
 wherein the etched portions of the common voltage line are formed at the region corresponding to the sealant in the non-displaying unit so that the sealant is exposed through the etched portions to provide a visual view of the sealant,
 wherein the conductive balls are directly contacted to the common voltage line on the first substrate.
12. The device according to claim 11, wherein the etched portions are formed along a main line portion of the common voltage line and forming a plurality of protrusions extending from the main line portion.
13. The device according to claim 11, wherein the etched portions correspond to a plurality of windows in the common voltage line.

* * * * *

专利名称(译)	液晶显示装置		
公开(公告)号	US8373840	公开(公告)日	2013-02-12
申请号	US13/011422	申请日	2011-01-21
[标]申请(专利权)人(译)	乐金显示有限公司		
申请(专利权)人(译)	LG DISPLAY CO. , LTD.		
当前申请(专利权)人(译)	LG DISPLAY CO. , LTD.		
[标]发明人	JEONG DUK YOUNG		
发明人	JEONG, DUK-YOUNG		
IPC分类号	G02F1/1339		
CPC分类号	G02F1/1339 G02F1/1345 G02F1/1309 G02F2203/69		
优先权	1020070055705 2007-06-07 KR 1020060061597 2006-06-30 KR		
其他公开文献	US20110211151A1		
外部链接	Espacenet USPTO		

摘要(译)

液晶显示模块包括观察区域，以允许在粘合基板之后进行目视检查，以检查可能被公共电压线阻挡的密封剂。液晶显示装置的一个实施例包括在第一基板上的第一电极，在第二基板上的第二电极和第三电极，第二电极在第一部分处与第一电极电接触，在第二部分处与第三电极电接触，包括透明导电材料，在密封剂区域中将第一和第二基板连接在一起的密封剂，第一和第二电极之间的密封剂以及包括用于电连接第一和第二电极的多个导电球的密封剂，以及液体附着的第一和第二基板之间以及密封剂内的晶体层。

